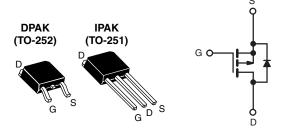


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	- 200					
R _{DS(on)} (Ω)	V _{GS} = - 10 V 3.0					
Q _g (Max.) (nC)	8.9					
Q _{gs} (nC)	2.1					
Q _{gd} (nC)	3.9					
Configuration	Single					



P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9210, SiHFR9210)
- Straight Lead (IRFU9210, SiHFU9210)
- Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The power MOSFETs technology is the key to Vishay's advanced line of Power MOSFET transistors. The efficient geometry and unique processing of the Power MOSFET design achieve very low on-state resistance combined with high transconductance and extreme device ruggedness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION				
Package	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lead (Pb)-free and Halogen-free	SiHFR9210-GE3	SiHFR9210TR-GE3	SiHFU9210-GE3	
Lood (Ph) free	IRFR9210PbF	IRFR9210TRPbF ^a	IRFU9210PbF	
Lead (Pb)-free	SiHFR9210-E3	SiHFR9210T-E3ª	SiHFU9210-E3	

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	- 200	V	
Gate-Source Voltage			V _{GS}	± 20	V	
Continuous Drain Current	1-	- 1.9				
Continuous Drain Current	I _D	- 1.2	А			
Pulsed Drain Current ^a	I _{DM}	- 7.6				
Linear Derating Factor		0.20	W/°C			
Linear Derating Factor (PCB Mount) ^e		0.020	W/ C			
Single Pulse Avalanche Energy ^b		E _{AS}	300	mJ		
Repetitive Avalanche Current ^a		I _{AR}	- 1.9	А		
Repetitive Avalanche Energy ^a		E _{AR}	2.5	mJ		
Maximum Power Dissipation	D	25	14/			
Maximum Power Dissipation (PCB Mount) ^e	P _D 2.5		— W			
Peak Diode Recovery dV/dt ^c	dV/dt	- 5.0	V/ns			
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) ^d		260				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = -50$ V, starting $T_J = 25$ °C, L = 124 mH, $R_g = 25 \Omega$, $I_{AS} = -1.9$ A (see fig. 12). c. $I_{SD} \leq -1.9$ A, dI/dt ≤ 70 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C. d. 1.6 mm from case.

When mounted on 1" square PCB (FR-4 or G-10 material). e.

S13-0166-Rev. C, 04-Feb-13



HALOGEN

FREE



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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	-	110			
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	5.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = - 250 μA	- 200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = - 1 mA	-	- 0.23	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μA	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	_	- 200 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	- 100 - 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 1.1 A ^b	-	-	3.0	Ω
Forward Transconductance	9 _{fs}	-	- 50 V, I _D = - 1.1 A	0.98	-	-	S
Dynamic					I		1
Input Capacitance	Ciss		$V_{GS} = 0 V,$	-	170	-	
Output Capacitance	C _{oss}		$V_{\rm DS} = -25 \rm V,$	-	54	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	16	-	
Total Gate Charge	Qg			-	-	8.9	
Gate-Source Charge	Q_gs	V _{GS} = - 10 V	$I_D = -1.3 \text{ A}, V_{DS} = -160 \text{ V},$ see fig. 6 and 13^{b}	-	-	2.1	nC
Gate-Drain Charge	Q _{gd}		see lig. o and ro	-	-	3.9	
Turn-On Delay Time	t _{d(on)}			-	8.0	-	
Rise Time	t _r	V _{DD} = -	100 V, I _D = - 2.3 A,	-	12	-	
Turn-Off Delay Time	t _{d(off)}		$R_D = 41 \Omega$, see fig. 10^{b}	-	11	-	ns
Fall Time	t _f			-	13	-	1
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") f	rom	-	4.5	-	nH
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	
Drain-Source Body Diode Characteristic	s				-	-	
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the		-	-	- 1.9	А
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	- 7.6	~
Body Diode Voltage	V_{SD}	T _J = 25 °C,	$I_{\rm S}$ = - 1.9 A, $V_{\rm GS}$ = 0 V ^b	-	-	- 5.8	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C I	= - 2.3 A, dl/dt = 100 A/µs ^b	-	110	220	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$J = 25 \text{ C}, I_{\text{F}} =$	$= -2.3 \text{ A}, \text{ u/ul} = 100 \text{ A/}\mu\text{S}^{3}$	-	0.56	1.1	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	v Ls and	Ln)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

VISHAY.

IRFR9210, IRFU9210, SiHFR9210, SiHFU9210

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

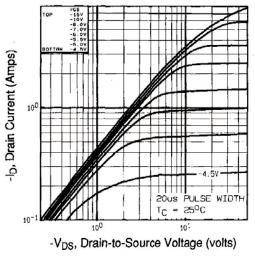


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

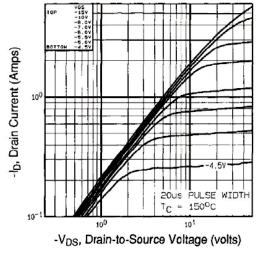


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

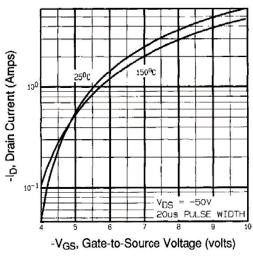


Fig. 3 - Typical Transfer Characteristics

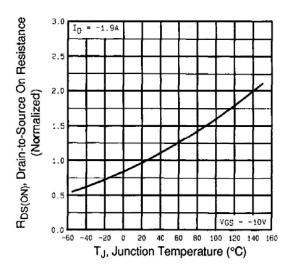


Fig. 4 - Normalized On-Resistance vs. Temperature

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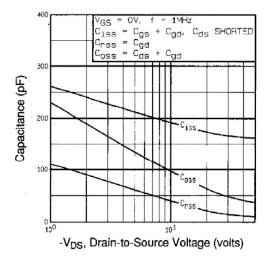
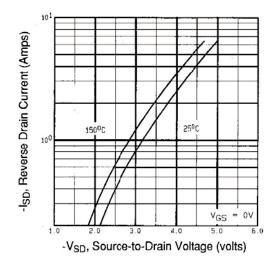
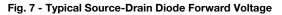


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





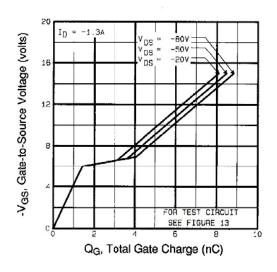


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

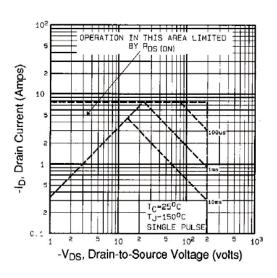


Fig. 8 - Maximum Safe Operating Area



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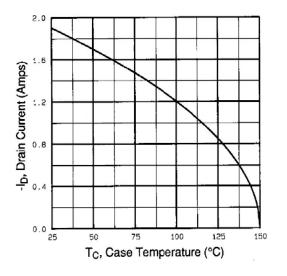


Fig. 9 - Maximum Drain Current vs. Case Temperature

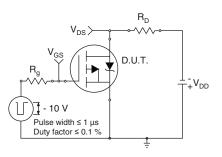


Fig. 10a - Switching Time Test Circuit

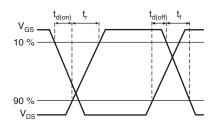


Fig. 10b - Switching Time Waveforms

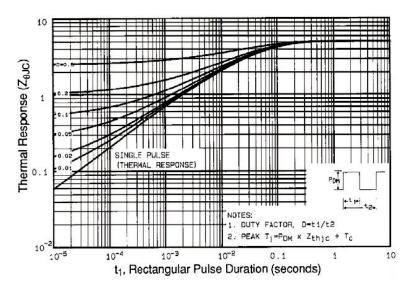


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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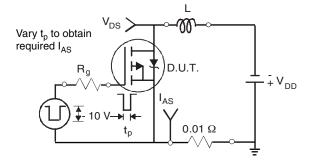


Fig. 12a - Unclamped Inductive Test Circuit

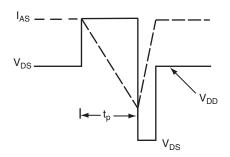


Fig. 12b - Unclamped Inductive Waveforms

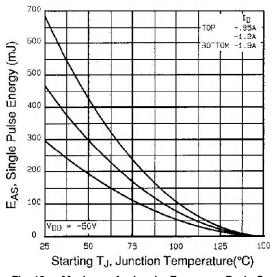
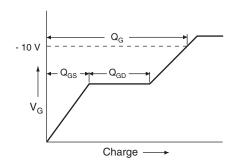
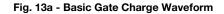
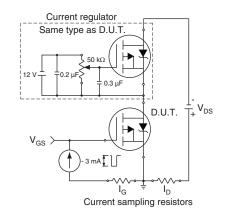


Fig. 12c - Maximum Avalanche Energy vs. Drain Current









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Peak Diode Recovery dV/dt Test Circuit

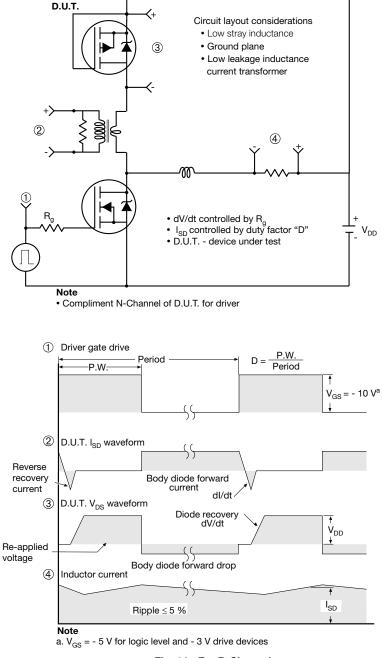
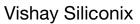


Fig. 14 - For P-Channel

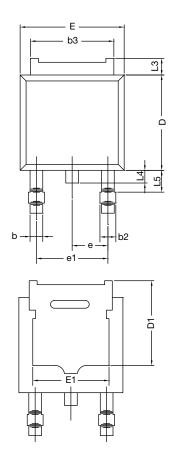
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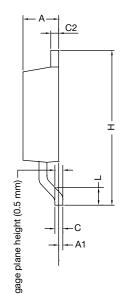
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TO-252AA Case Outline





	MILLIN	IETERS	INCHES				
DIM.	MIN.	MAX.	MIN.	MAX.			
А	2.18	2.38	0.086	0.094			
A1	-	0.127	-	0.005			
b	0.64	0.88	0.025	0.035			
b2	0.76	1.14	0.030	0.045			
b3	4.95	5.46	0.195	0.215			
С	0.46	0.61	0.018	0.024			
C2	0.46	0.89	0.018	0.035			
D	5.97	6.22	0.235	0.245			
D1	4.10	-	0.161	-			
Е	6.35	6.73	0.250	0.265			
E1	4.32	-	0.170	-			
Н	9.40	10.41	0.370	0.410			
е	2.28	BSC	0.090	0.090 BSC			
e1	4.56	BSC	0.180 BSC				
L	1.40	1.78	0.055	0.070			
L3	0.89	1.27	0.035	0.050			
L4	-	1.02	-	0.040			
L5	1.01	1.52	0.040	0.060			
ECN: T16- DWG: 534	0236-Rev. P, [•] 7	16-May-16					

Notes

• Dimension L3 is for reference only.



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TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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